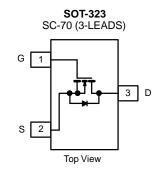
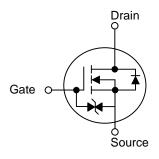


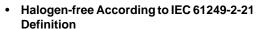
RSU002N06T106-VB Datasheet N-Channel 60-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | |
|---------------------|-----------------------------|---------------------|--|--|--|
| V _{DS} (V) | $R_{DS(on)}$ (Ω) | I _D (mA) | | | |
| 60 | 2 at V _{GS} = 10 V | 300 | | | |





FEATURES





COMPLIANT HALOGEN

FREE

Low On-Resistance: 2 Ω

Low Threshold: 2 V (typ.)

· Low Input Capacitance: 25 pF

Fast Switching Speed: 25 ns

Low Input and Output Leakage

Trench Power MOSFET

Compliant to RoHS Directive 2002/95/EC

BENEFITS

- Low Offset Voltage
- Low-Voltage Operation
- Easily Driven Without Buffer
- **High-Speed Circuits**
- Low Error Voltage

APPLICATIONS

- Direct Logic-Level Interface: TTL/CMOS
- Drivers: Relays, Solenoids, Lamps, Hammers, Display, Memories, Transistors, etc.
- **Battery Operated Systems**
- Solid-State Relays

| ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted | | | | | |
|--------------------------------------------------------------------------------|-------------------------|----------------------------------|----------------------|------|--|
| Parameter | Symbol | Limit | Unit | | |
| Drain-Source Voltage | | V_{DS} | 60 | V | |
| Gate-Source Voltage | | V _{GS} | V _{GS} ± 20 | | |
| Continuous Drain Current (T _{.I} = 150 °C) ^b | T _A = 25 °C | - I _D | 300 | mA | |
| Continuous Diain Current (1) = 130 °C) | T _A = 100 °C | | 190 | | |
| Pulsed Drain Current ^a | | I _{DM} | 800 | | |
| Davies Discination b | T _A = 25 °C | P _D | 0.35 | W | |
| Power Dissipation ^b | T _A = 100 °C | | 0.14 | | |
| Maximum Junction-to-Ambient ^b | | R _{thJA} | 350 | °C/W | |
| Operating Junction and Storage Temperature Range | | T _{J,} T _{stg} | - 55 to 150 | °C | |

Notes:

- a. Pulse width limited by maximum junction temperature.
- b. Surface Mounted on FR4 board.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.



| | | erwise noted | Limits | | | | |
|-----------------------------------------|---------------------|--------------------------------------------------------------------------------|---------|-------------------|--------|-------|--|
| Parameter | Symbol | Test Conditions | Min. | Typ. ^a | Max. | Unit | |
| Static | | | • | • | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 10 \mu\text{A}$ | 60 | | | V | |
| Gate-Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ | 1 | | 2.5 | V | |
| | | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 10 | | |
| | | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 15 \text{ V}$ | | | 1 | μA | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 10 \text{ V}$ | | | ± 150 | nA | |
| | | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 10 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$ | | | ± 1000 | | |
| | | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 5 \text{ V}$ | | | ± 100 | | |
| Zone Onto Vallana Busin Oursell | 1 | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$ | 50 | | 500 | μA | |
| On-State Drain Current ^a | I _{D(on)} | $V_{GS} = 10 \text{ V}, V_{DS} = 7.5 \text{ V}$ | 800 | | | mA | |
| | | $V_{GS} = 4.5 \text{ V}, V_{DS} = 10 \text{ V}$ | 500 | 500 | | | |
| Drain-Source On-Resistance ^a | R _{DS(on)} | $V_{GS} = 10 \text{ V}, I_D = 500 \text{ mA}$ | | 2 | | Ω | |
| | | $V_{GS} = 4.5 \text{ V}, I_D = 200 \text{ mA}$ | | 4 | | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 10 V, I _D = 200 mA | 100 | | | mS | |
| Diode Forward Voltage | V _{SD} | $I_S = 200 \text{ mA}, V_{GS} = 0 \text{ V}$ | | | 1.3 | V | |
| Dynamic ^a | | | | 1 | | | |
| Total Gate Charge | Qg | $V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}$ $I_{D} \cong 250 \text{ mA}$ | 5 V 0.4 | | 0.6 | nC | |
| Input Capacitance | C _{iss} | | | 30 | | pF | |
| Output Capacitance | C _{oss} | $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}$ | | 6 | | | |
| Reverse Transfer Capacitance | C _{rss} | f = 1 MHz | | 2.5 | | | |
| Switching ^{a, b, c} | | | | | | | |
| Turn-On Time | t _{d(on)} | $V_{DD} = 30 \text{ V}, R_{L} = 150 \Omega$ | | | 25 | ns ns | |
| Turn-Off Time | t _{d(off)} | $I_D \cong 200 \text{ mA}, V_{GEN} = 10 \text{ V}, R_G = 10 \Omega$ | | | 35 | | |

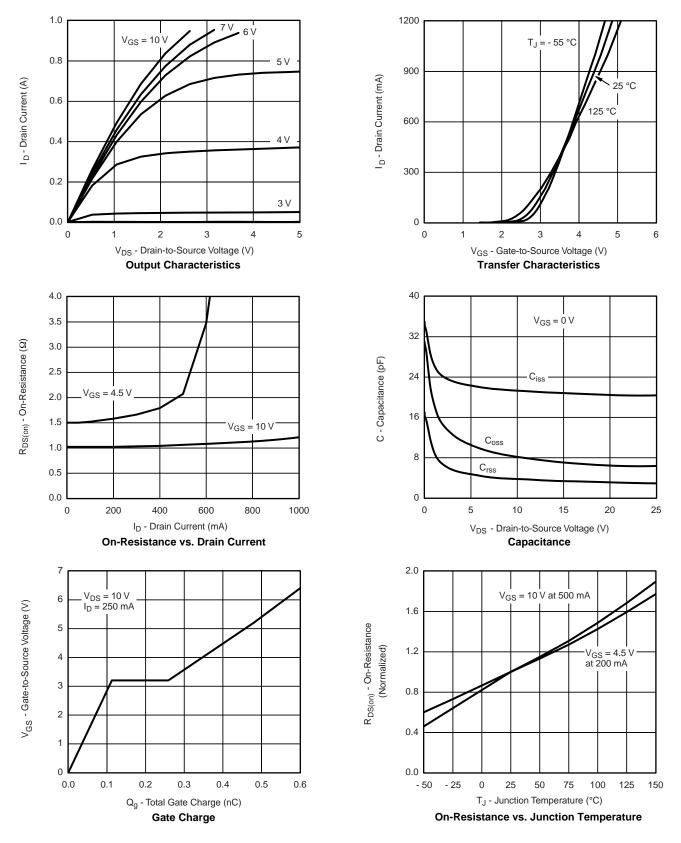
Notes:

- a. For DESIGN AID ONLY, not subject to production testing.
- b. Pulse test: PW \leq 300 μ s duty cycle \leq 2 %.
- c. Switching time is essentially independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

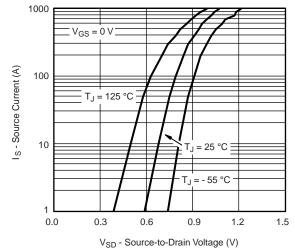


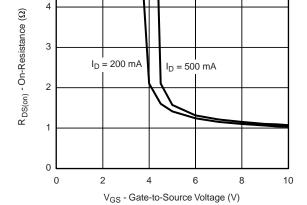
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

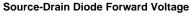


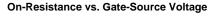


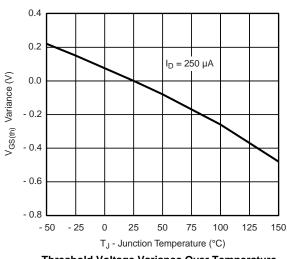
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

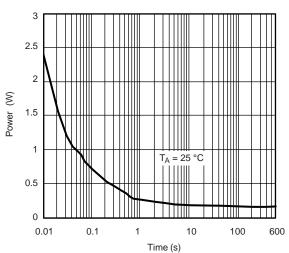






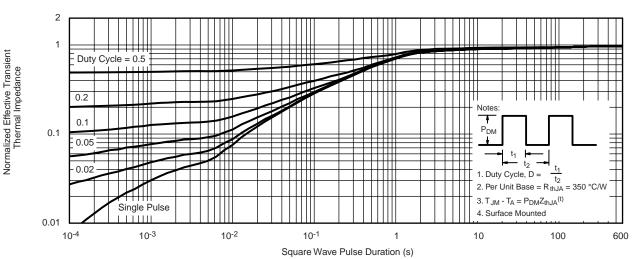






Threshold Voltage Variance Over Temperature

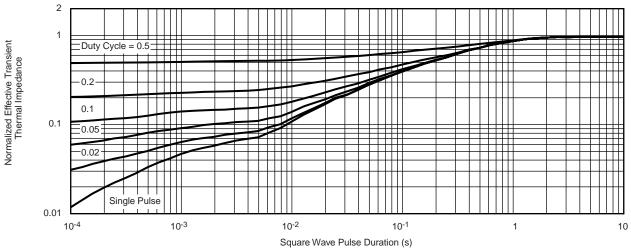
Single Pulse Power, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



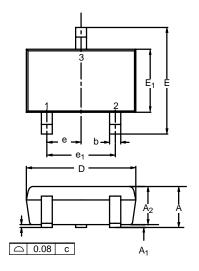
Normalized Thermal Transient Impedance, Junction-to-Foot

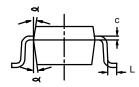
Note

- · The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Foot (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



SC-70: 3-LEADS



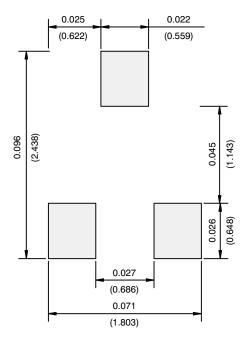


| | MIL | LIMET | ERS | INCHES | | |
|---------------------------------------------|---------|-------|------|----------|-------|-------|
| Dim | Min | Nom | Max | Min | Nom | Max |
| Α | 0.90 | - | 1.10 | 0.035 | _ | 0.043 |
| A ₁ | _ | - | 0.10 | _ | _ | 0.004 |
| A ₂ | 0.80 | - | 1.00 | 0.031 | _ | 0.039 |
| b | 0.25 | - | 0.40 | 0.010 | _ | 0.016 |
| С | 0.10 | - | 0.25 | 0.004 | - | 0.010 |
| D | 1.80 | 2.00 | 2.20 | 0.071 | 0.079 | 0.087 |
| Е | 1.80 | 2.10 | 2.40 | 0.071 | 0.083 | 0.094 |
| E ₁ | 1.15 | 1.25 | 1.35 | 0.045 | 0.049 | 0.053 |
| е | 0.65BSC | | | 0.026BSC | | |
| e ₁ | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| L | 0.10 | 0.20 | 0.30 | 0.004 | 0.008 | 0.012 |
| ø | 7°Nom | | | 7°Nom | | |
| ECN: S-03946—Rev. C, 09-Jul-01 DWG: 5549 | | | | | | |



7

RECOMMENDED MINIMUM PADS FOR SC-70: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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